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| INFORMATION DISCLOSURE STATEMENT BY APPLICANT PTO FORM 1449 | ATTY. DOCKET NO. 2345/169 | SERIAL NO. Not yet assigned |
| | APPLICANT(s) Walter HEITMANN et al. | |
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U. S. PATENT DOCUMENTS

| EXAMINER INITIAL | PATENT NUMBER | PATENT DATE | NAME |
|------------------|---------------|-------------------|-------------------|
| KSW | 5,802,236* | September 1, 1998 | DiGiovanni et al. |
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*Copy of reference is not enclosed because reference is cited and described in International Search Report (copy of reference provided by International Searching Authority).

FOREIGN PATENT DOCUMENTS

| EXAMINER INITIAL | DOCUMENT NUMBER | DATE | COUNTRY | TRANSLATION | |
|------------------|-----------------|------------------|---------|-------------|----|
| | | | | YES | NO |
| KSW | WO 99/00956 | January 7, 1999 | PCT | X* | |
| KSW | EP 0 753 944 | January 15, 1997 | EPO | X* | |

*Copy of reference is not enclosed because reference is cited and described in International Search Report (copy of reference provided by International Searching Authority).

OTHER DOCUMENTS

| EXAMINER INITIAL | | AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC |
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| KSW | | *Koops, H. W. P. et al., "Photonic Crystals Built By Three-Dimensional Additive Lithography Enable Integrated Optics Of High Density", Proceedings Of the SPIE, US, Bellingham, Virginia, vol. 2849, August 5, 1996, pages 248-256. |

*Copy of reference is not enclosed because reference is cited and described in International Search Report (copy of reference provided by International Searching Authority).

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| EXAMINER | <i>Kevin J. Wood</i> | DATE CONSIDERED | <i>8/14/03</i> |
| EXAMINER: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. | | | |

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